



Vincotech

fastPACK 0 SiC		1200 V / 36 mΩ
Topology features		
<ul style="list-style-type: none">• Kelvin Emitter for improved switching performance• Integrated DC capacitor• Open Emitter configuration• Temperature sensor		
Component features		flow 0 12 mm housing
<ul style="list-style-type: none">• Easy paralleling• Low on-resistance• Fast switching speed• Fast recovery body diode		
Housing features		
<ul style="list-style-type: none">• Base isolation: Al2O3• Clip-in, reliable mechanical connection, qualified for wave soldering• Convex shaped substrate for superior thermal contact• Thermo-mechanical push-and-pull force relief• Press-fit pin• Reliable cold welding connection		
Target applications		Schematic
<ul style="list-style-type: none">• Charging Stations• Power Supply		
Types		
<ul style="list-style-type: none">• 10-PZ124PA036MR-L629F18Y		



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
H-Bridge Switch				
Drain-source voltage	V_{DSS}		1200	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$	28	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	84	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	57	W
Gate-source voltage	V_{GSS}		-4 / 21	V
		dynamic	-4 / 23	
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Capacitor (DC)

Maximum DC voltage	V_{MAX}		1000	V
Operation Temperature	T_{op}		-55 ... 125	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1\text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				9,15	mm
Comparative Tracking Index	CTI			≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

H-Bridge Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		18		21	25 125 150		34,8 56,4 65	45 ⁽¹⁾		mΩ
Gate-source threshold voltage	$V_{GS(th)}$		0		0,0111	25	2,8	3,5	4,8		V
Gate to Source Leakage Current	I_{GSS}		21	0		25			100		nA
Zero Gate Voltage Drain Current	I_{DSS}		0	1200		25		1	80		μA
Internal gate resistance	r_g							1			Ω
Gate charge	Q_g	$f = 1 \text{ MHz}$	0/18	800	21	25		91			nC
Gate to source charge	Q_{GS}							20			
Gate to drain charge	Q_{GD}							24			
Short-circuit input capacitance	C_{iss}	$f = 1 \text{ MHz}$	0	800	0	25		2335			pF
Short-circuit output capacitance	C_{oss}							70			
Reverse transfer capacitance	C_{rss}							5			
Diode forward voltage	V_{SD}		0		21	25		3,3			V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,67		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Dynamic										
Turn-on delay time	$t_{d(on)}$				25 125 150		23,66 24,1 24,25			ns
Rise time	t_r				25 125 150		9,16 8,85 8,87			ns
Turn-off delay time	$t_{d(off)}$		$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$		25 125 150		22,68 25,6 26,37			ns
Fall time	t_f				25 125 150		5,26 4,81 4,95			ns
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD}=0,143 \mu C$ $Q_{fFWD}=0,256 \mu C$ $Q_{fFWD}=0,345 \mu C$			25 125 150		0,292 0,302 0,327			mWs
Turn-off energy (per pulse)	E_{off}			±16	600	30	0,047 0,047 0,049			mWs
Peak recovery current	I_{RRM}				25 125 150		20,46 22,24 23,57			A
Reverse recovery time	t_{rr}				25 125 150		12,47 20,96 22,23			ns
Recovered charge	Q_r	$di/dt=3697 A/\mu s$ $di/dt=3631 A/\mu s$ $di/dt=4134 A/\mu s$			25 125 150		0,143 0,256 0,345			μC
Reverse recovered energy	E_{rec}				25 125 150		0,027 0,079 0,117			mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$				25 125 150		4788,08 1225,34 2042,95			A/μs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		10		nF
Tolerance							-10		10	%
Dissipation factor		$f = 1$ kHz				25		0,1		%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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H-Bridge Switch Characteristics

figure 1. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

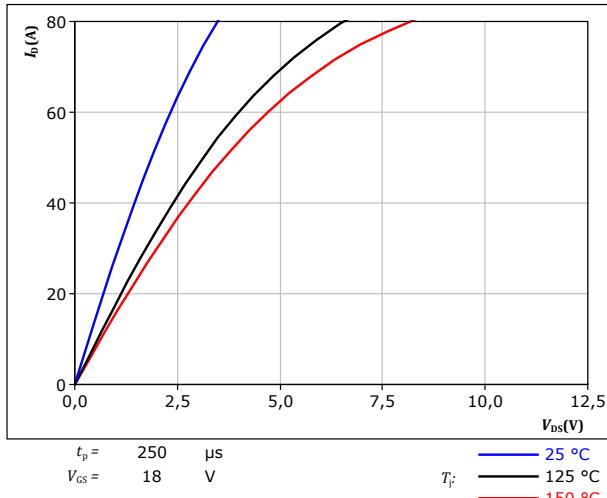


figure 2. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

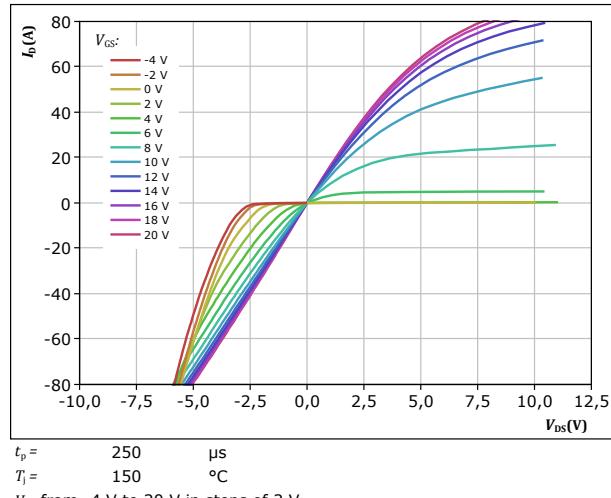


figure 3. MOSFET

Typical transfer characteristics
 $I_D = f(V_{GS})$

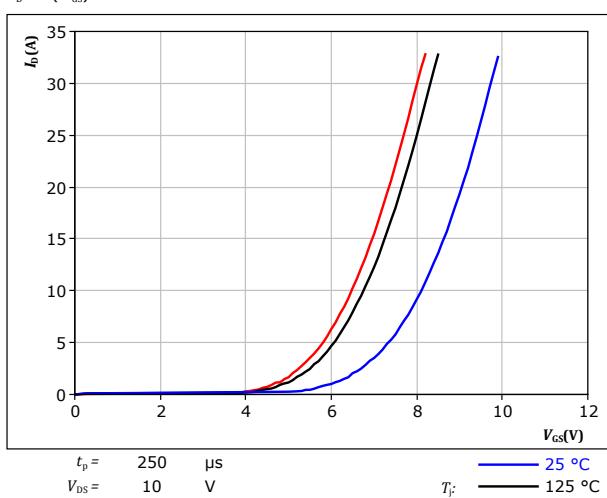
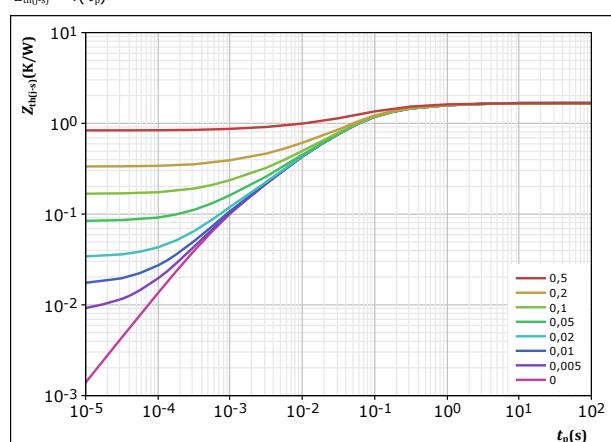


figure 4. MOSFET

Transient thermal impedance as a function of pulse width
 $Z_{th(t-s)} = f(t_p)$





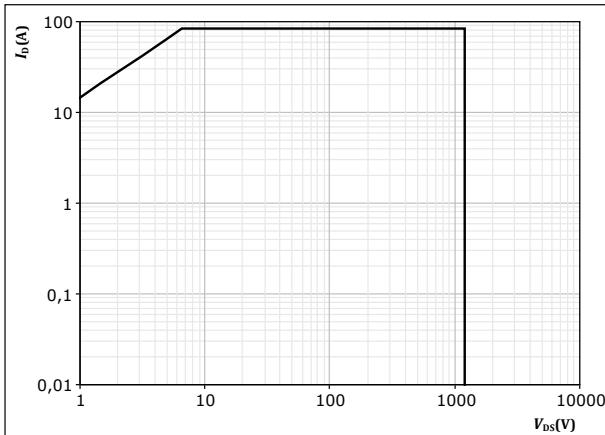
Vincotech

H-Bridge Switch Characteristics

figure 5.

Safe operating area

$$I_D = f(V_{DS})$$

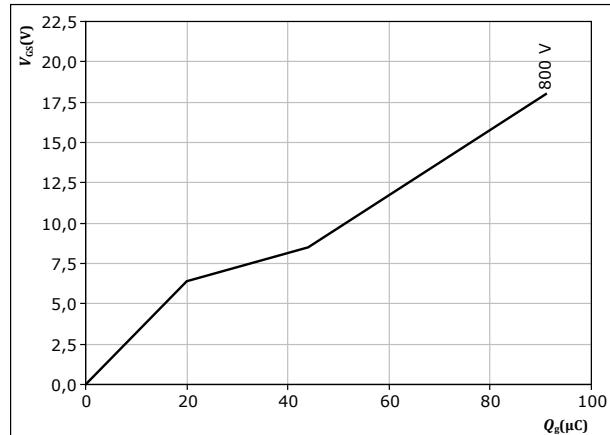


MOSFET

figure 6.

Gate voltage vs gate charge

$$V_{GS} = f(Q_g)$$



MOSFET

D = single pulse

T_s = 80 °C

V_{GS} = 18 V

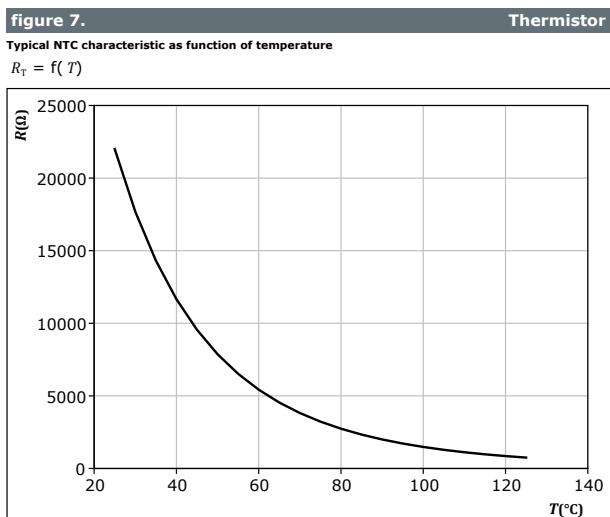
T_j = $T_{j\max}$

I_D = 21 A

T_j = 25 °C



Thermistor Characteristics



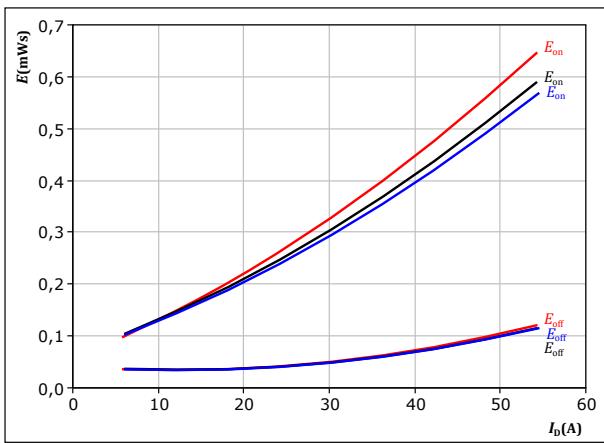


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H-Bridge Switching Characteristics

figure 8.

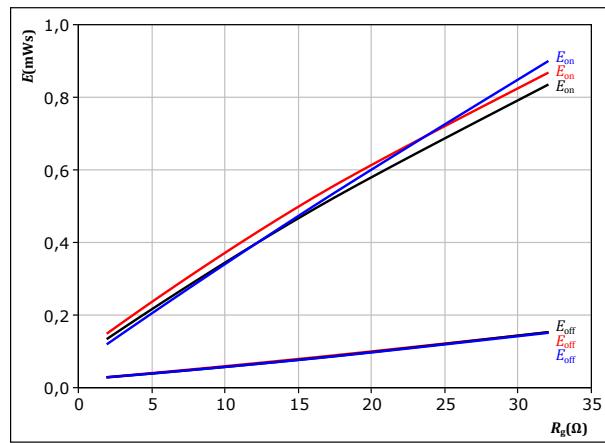
Typical switching energy losses as a function of drain current
 $E = f(I_D)$



MOSFET

figure 9.

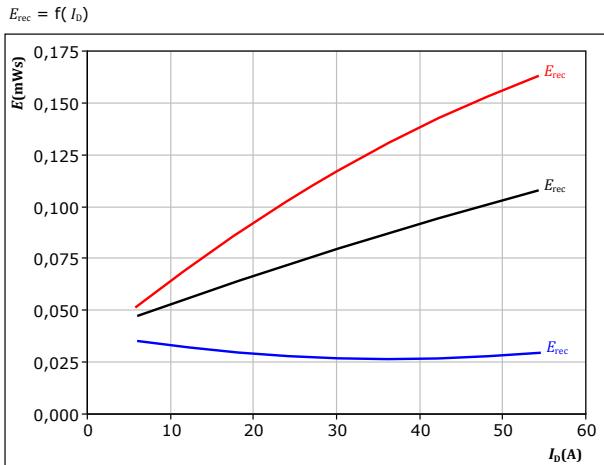
Typical switching energy losses as a function of MOSFET turn on gate resistor
 $E = f(R_g)$



MOSFET

figure 10.

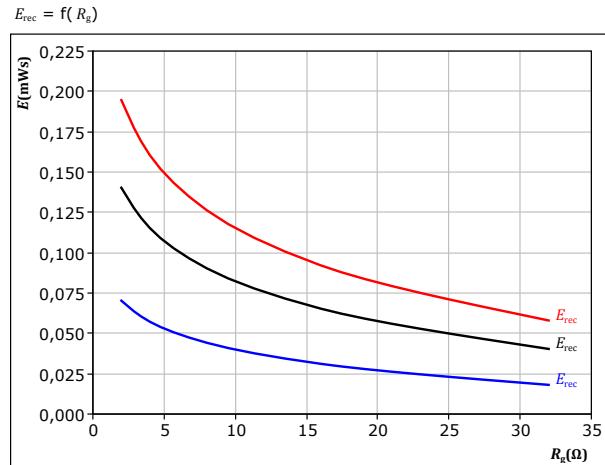
Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$



MOSFET

figure 11.

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor
 $E_{rec} = f(R_g)$



MOSFET

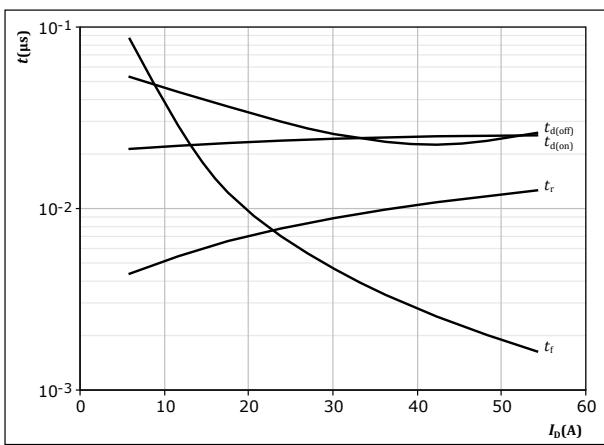


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H-Bridge Switching Characteristics

figure 12.

Typical switching times as a function of drain current
 $t = f(I_D)$



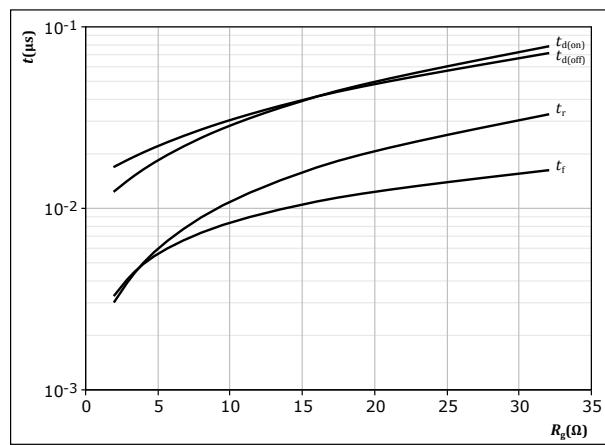
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{DS} = 600 \text{ V}$
 $V_{GS} = \pm 16 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

MOSFET

figure 13.

Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$



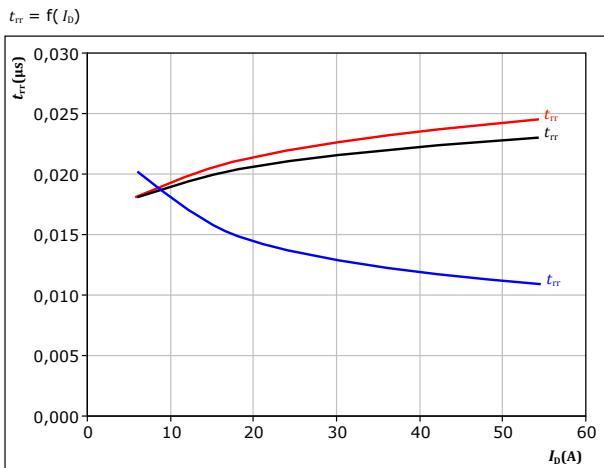
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{DS} = 600 \text{ V}$
 $V_{GS} = \pm 16 \text{ V}$
 $I_D = 30 \text{ A}$

MOSFET

figure 14.

Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$

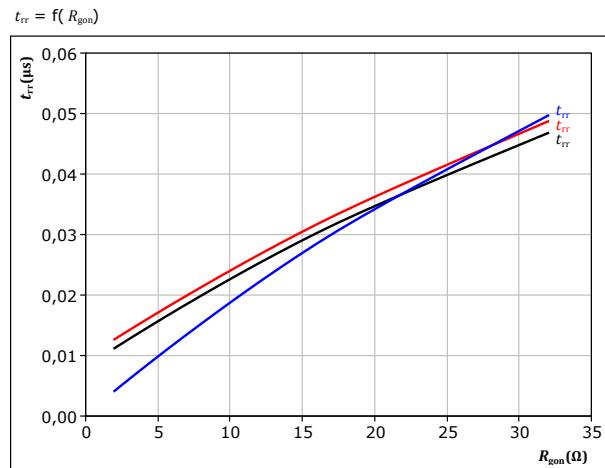


At $V_{DS} = 600 \text{ V}$
 $V_{GS} = \pm 16 \text{ V}$
 $R_{gon} = 8 \Omega$

MOSFET

figure 15.

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$



At $V_{DS} = 600 \text{ V}$
 $V_{GS} = \pm 16 \text{ V}$
 $I_D = 30 \text{ A}$

MOSFET



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H-Bridge Switching Characteristics

figure 16.

Typical recovered charge as a function of drain current
 $Q_r = f(I_D)$

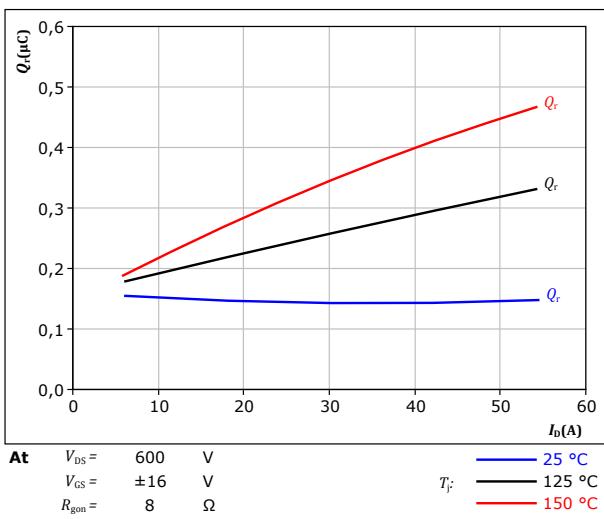


figure 18.

Typical peak reverse recovery current as a function of drain current
 $I_{RM} = f(I_D)$

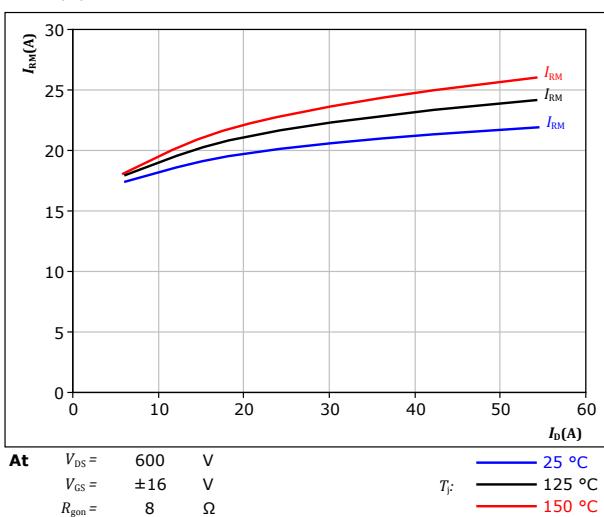


figure 17.

Typical recovered charge as a function of MOSFET turn on gate resistor
 $Q_r = f(R_{gon})$

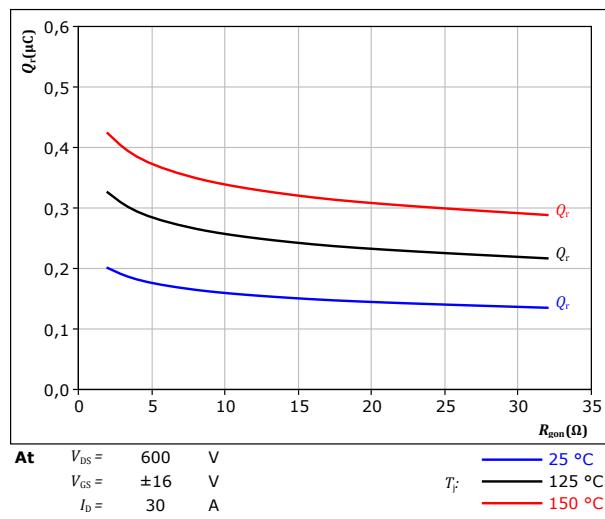
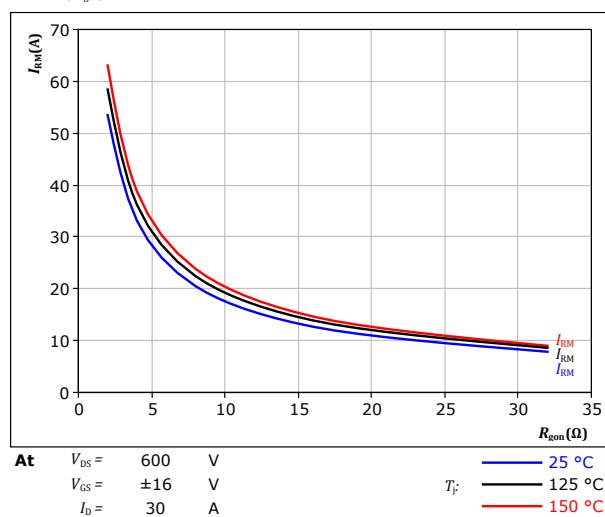


figure 19.

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor
 $I_{RM} = f(R_{gon})$





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H-Bridge Switching Characteristics

figure 20. MOSFET

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

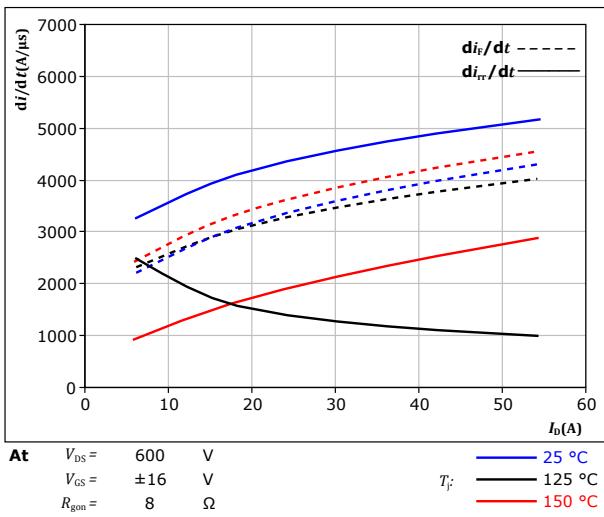


figure 21. MOSFET

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

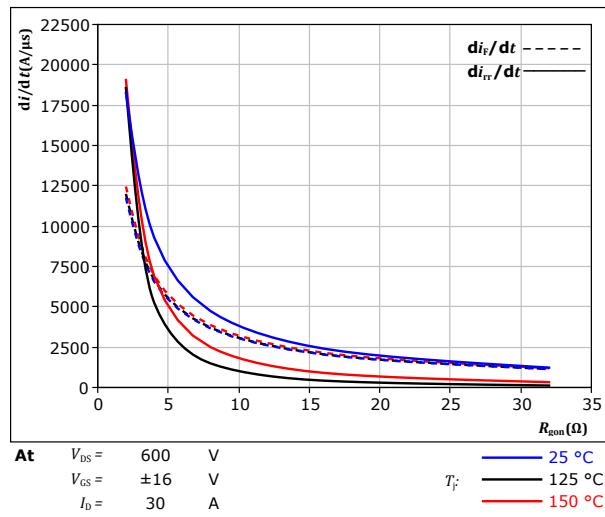
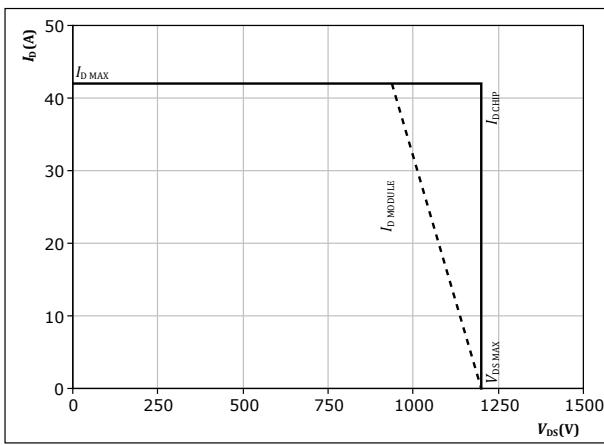


figure 22. MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$





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H-Bridge Switching Definitions

figure 23. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

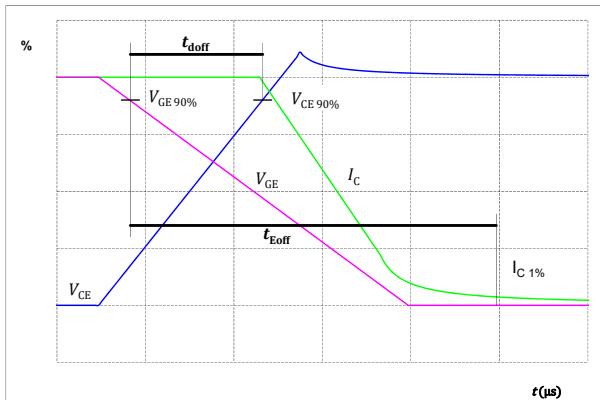


figure 24. MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

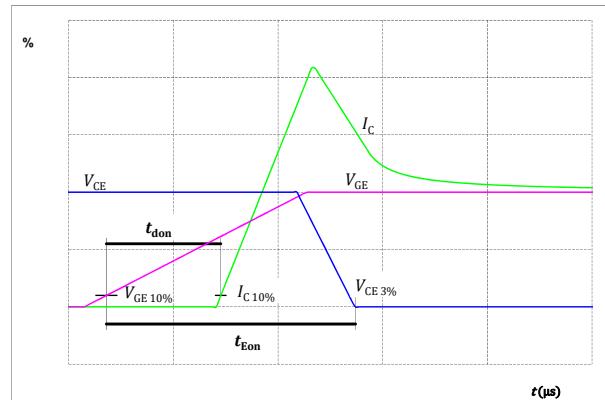


figure 25. MOSFET

Turn-off Switching Waveforms & definition of t_f

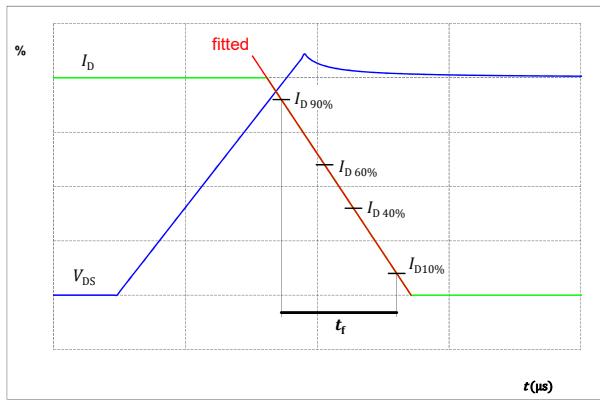
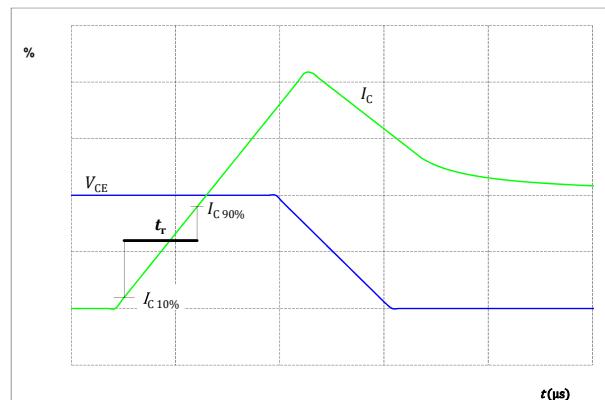


figure 26. MOSFET

Turn-on Switching Waveforms & definition of t_r





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H-Bridge Switching Definitions

figure 27.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

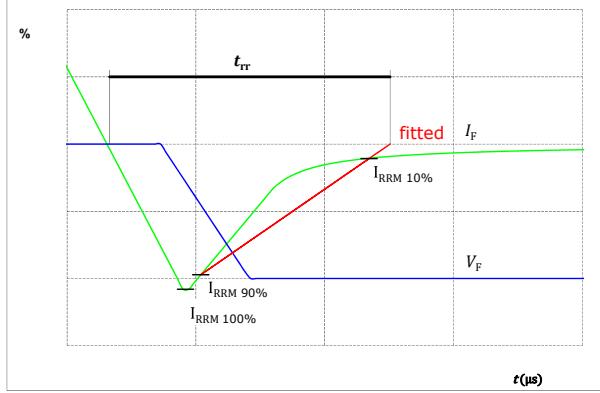


figure 28.

Turn-on Switching Waveforms & definition of t_{Qrr} (t_{Qrr} = integrating time for Q_{rr})

FWD

Turn-on Switching Waveforms & definition of t_{Qrr} (t_{Qrr} = integrating time for Q_{rr})

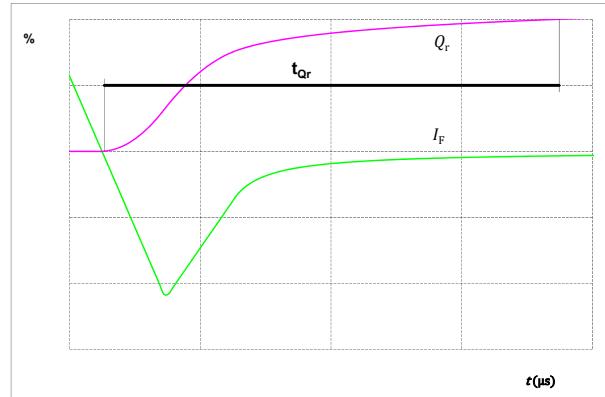
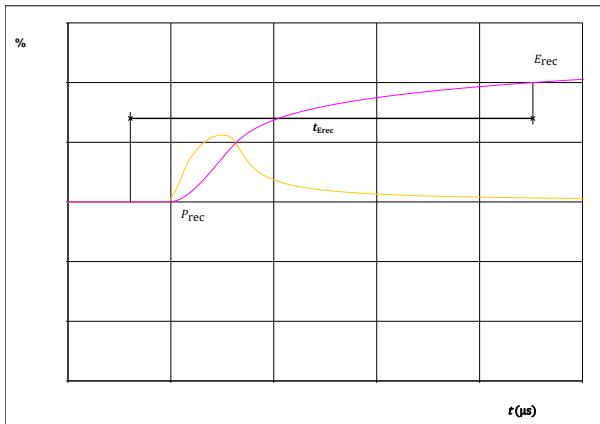


figure 29.

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})

FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})



**10-PZ124PA036MR-L629F18Y**

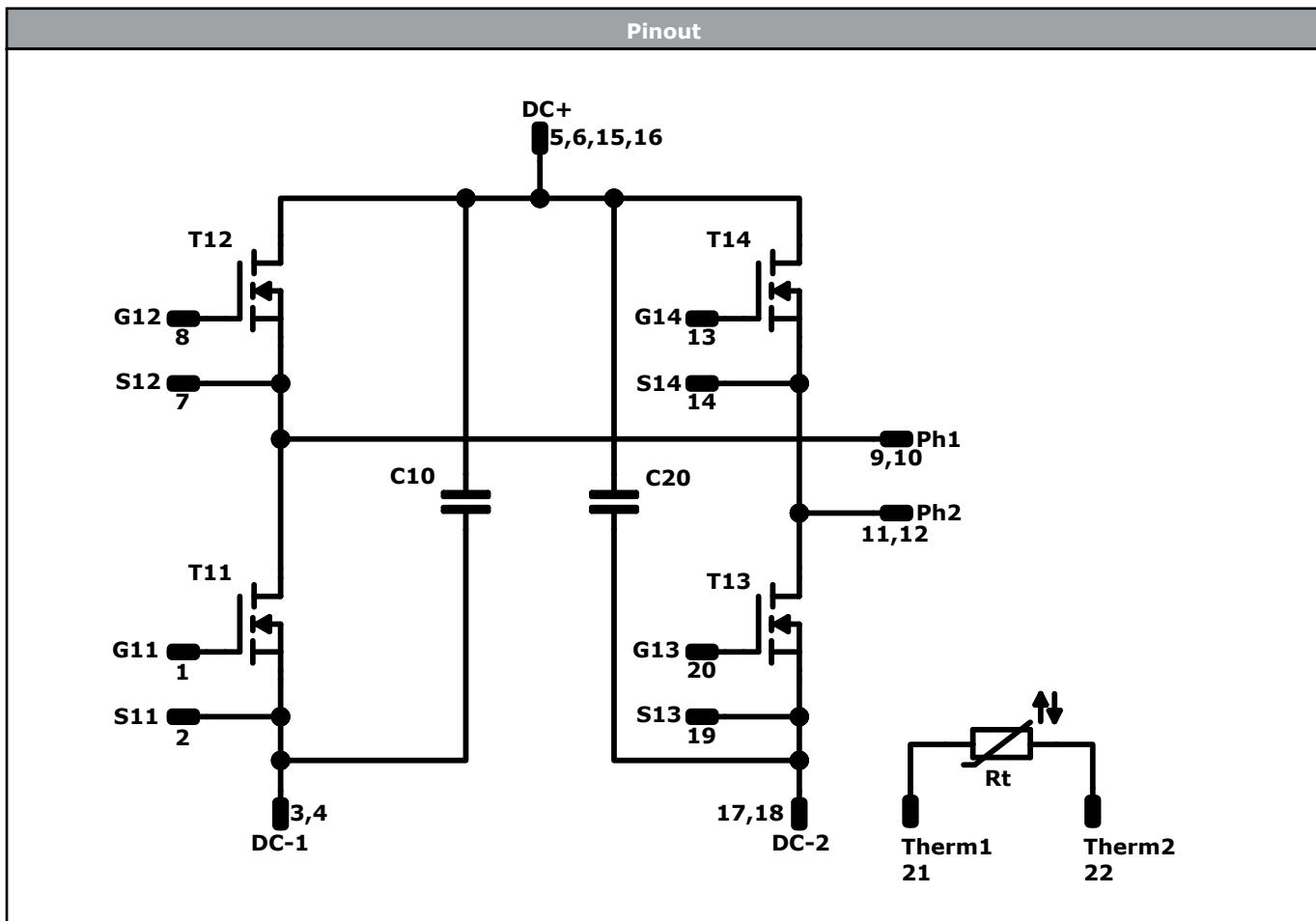
datasheet

Vincotech

Ordering Code																																																																																																		
Version				Ordering Code																																																																																														
Without thermal paste				10-PZ124PA036MR-L629F18Y																																																																																														
With thermal paste (5,2 W/mK, PTM6000HV)				10-PZ124PA036MR-L629F18Y-/7/																																																																																														
With thermal paste (3,4 W/mK, PSX-P7)				10-PZ124PA036MR-L629F18Y-/3/																																																																																														
Marking																																																																																																		
	Text	Name NN-NNNNNNNNNNNNN- TTTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS																																																																																												
	Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY																																																																																													
Outline																																																																																																		
Pin table [mm]	<p>center of press-fit pinhead for connection parameter see the handling instruction</p> <p>15.92/16.15</p> <p>16.75</p> <p>1-22</p> <p>Tolerance of positions ±0.5mm of the end of pins. Dimension of coordinate axis is only offset without tolerance.</p>																																																																																																	
<table border="1"><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>0</td><td>22,5</td><td>G11</td></tr><tr><td>2</td><td>2,9</td><td>22,5</td><td>S11</td></tr><tr><td>3</td><td>8,3</td><td>22,5</td><td>DC-1</td></tr><tr><td>4</td><td>10,8</td><td>22,5</td><td>DC-1</td></tr><tr><td>5</td><td>19,6</td><td>22,5</td><td>DC+</td></tr><tr><td>6</td><td>22,1</td><td>22,5</td><td>DC+</td></tr><tr><td>7</td><td>29,1</td><td>22,5</td><td>S12</td></tr><tr><td>8</td><td>32</td><td>22,5</td><td>G12</td></tr><tr><td>9</td><td>33,5</td><td>17,8</td><td>Ph1</td></tr><tr><td>10</td><td>33,5</td><td>15,3</td><td>Ph1</td></tr><tr><td>11</td><td>33,5</td><td>7,2</td><td>Ph2</td></tr><tr><td>12</td><td>33,5</td><td>4,7</td><td>Ph2</td></tr><tr><td>13</td><td>32</td><td>0</td><td>G14</td></tr><tr><td>14</td><td>29,1</td><td>0</td><td>S14</td></tr><tr><td>15</td><td>22,1</td><td>0</td><td>DC+</td></tr><tr><td>16</td><td>19,6</td><td>0</td><td>DC+</td></tr><tr><td>17</td><td>10,8</td><td>0</td><td>DC-2</td></tr><tr><td>18</td><td>8,3</td><td>0</td><td>DC-2</td></tr><tr><td>19</td><td>2,9</td><td>0</td><td>S13</td></tr><tr><td>20</td><td>0</td><td>0</td><td>G13</td></tr><tr><td>21</td><td>0</td><td>8</td><td>Therm1</td></tr><tr><td>22</td><td>0</td><td>14,5</td><td>Therm2</td></tr></tbody></table>	Pin	X	Y	Function	1	0	22,5	G11	2	2,9	22,5	S11	3	8,3	22,5	DC-1	4	10,8	22,5	DC-1	5	19,6	22,5	DC+	6	22,1	22,5	DC+	7	29,1	22,5	S12	8	32	22,5	G12	9	33,5	17,8	Ph1	10	33,5	15,3	Ph1	11	33,5	7,2	Ph2	12	33,5	4,7	Ph2	13	32	0	G14	14	29,1	0	S14	15	22,1	0	DC+	16	19,6	0	DC+	17	10,8	0	DC-2	18	8,3	0	DC-2	19	2,9	0	S13	20	0	0	G13	21	0	8	Therm1	22	0	14,5	Therm2						
Pin	X	Y	Function																																																																																															
1	0	22,5	G11																																																																																															
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4	10,8	22,5	DC-1																																																																																															
5	19,6	22,5	DC+																																																																																															
6	22,1	22,5	DC+																																																																																															
7	29,1	22,5	S12																																																																																															
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16	19,6	0	DC+																																																																																															
17	10,8	0	DC-2																																																																																															
18	8,3	0	DC-2																																																																																															
19	2,9	0	S13																																																																																															
20	0	0	G13																																																																																															
21	0	8	Therm1																																																																																															
22	0	14,5	Therm2																																																																																															



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Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14	MOSFET	1200 V	36 mΩ	H-Bridge Switch	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	



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Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction				
Handling instructions for flow 0 packages see vincotech.com website.				

Package data				
Package data for flow 0 packages see vincotech.com website.				

Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				

UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				



Document No.:	Date:	Modification:	Pages
10-PZ124PA036MR-L629F18Y-D1-14	2 May. 2023	Initial release	

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Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.